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Office of Intellectual Property Counsel 3M Innovative Properties Company

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651/733 1500

PATENT

56390US002

Transmittal of Patent Application - Rule 1.53(b)

Box: Patent Application

Commissioner for Patents Washington, DC 20231

Inventor(s):

Raymond Chi-Hing Chiu, Kenneth Robert Dillon

Title:

METHOD FOR FORMING MICROSTRUCTURES ON A SUBSTRATE USING A MOLD

1		×	Enclosed is the above-mentioned new patent application. It includes $\underline{5}$ sheet(s) of drawings.							
2. j 3.	2./	\boxtimes	Enclosed is an executed declaration or oath.							
	٧.	\boxtimes	sed are an application assignment to 3M Innovative Properties Company and a completed							
			Assignment Recordation Cover Sheet.							
4. Enclosed is a Certified Copy of Priority Document(s) (if foreign priority is claimed).										
5	5.		Enclosed is							
6. The fee for filing the application is computed as follows:										
Г	Claims As Filed									
-		(1	(5)							

Claims As Filed										
(1) For	(2) Number Filed		(3) Number Extra	(4) Rate		(5) Basic Fee \$740				
Total Claims	25	-20 =	5	х	\$18	\$90				
Independent Claims	4	-3 =	1	х	\$84	\$84				
Additional fee f	or filing one or	more multiple	dependent claims	\$280		\$				
				Total am	ount due →	\$914				

- 7.

 Please charge to Deposit Account 13-3723 any fees under 37 CFR 1.16 and 1.17 which may be required to file and during the entire pendency of this application. This authorization includes the fee for any extension of time under 37 CFR 1.136(a) that may be necessary. To the extent any such extension should become necessary it is hereby requested. A copy of this transmittal letter for fee processing is enclosed.
- Enclosed is a return receipt postcard

Respectfully submitted

Registration Number Telephone Number 41,622 651-736-3366 Date

Signature Bruce E. Black

Certificate of Express Mailing

Pursuant to 37 CFR 1.10 I certify that this application is being deposited on the date indicated below with the United States Postal Service "Express Mail Post Office to Addressee" service addressed to: Commissioner for Patents, Washington, DC 20231

Express Mail Mailing Label No.

EL 597 086 133 US

Date of Deposit October 9, 2001

October 9, 2001

Sherri K. W. Johnson

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